NCE N-Channel Super Trench Power MOSFET

Description

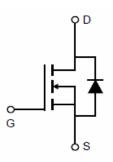
The NCEP30T17GU uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS}(\text{ON})}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

- V_{DS} =30V, I_{D} =170A $R_{DS(ON)}$ =0.97mΩ (typical) @ V_{GS} =10V $R_{DS(ON)}$ =1.25mΩ (typical) @ V_{GS} =4.5V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

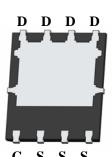
Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Schematic Diagram





Top View

Bottom View

100% UIS TESTED!

100% AVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP30T17GU	NCEP30T17GU	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_c=25°Cunless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _G S	±20	V
Drain Current-Continuous (Silicon Limited)	I _D	170	А
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	120	Α
Pulsed Drain Current (Package Limited)	I _{DM}	400	А
Maximum Power Dissipation	P _D	88	W
Derating factor		0.70	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	1350	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}\mathbb{C}$



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Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	$R_{ heta JC}$	1.42	°C/W	
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Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	30		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.0	1.5	2.0	V
Drain-Source On-State Resistance	Б	V _{GS} =10V, I _D =20A	-7	0.97	1.2	mΩ
Dialii-Source Oil-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =20A	-	1.25	1.5	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =20A		80	-	S
Dynamic Characteristics (Note4)		0,				
Input Capacitance	C _{lss}	V _{DS} =15V,V _{GS} =0V,	-	5300	-	PF
Output Capacitance	Coss	$V_{DS}=15V,V_{GS}=0V,$ $F=1.0MHz$	-	1800	-	PF
Reverse Transfer Capacitance	C _{rss}	r- Huivinz	-	100	-	PF
Switching Characteristics (Note 4)		0,0				
Turn-on Delay Time	t _{d(on)}		-	12	-	nS
Turn-on Rise Time	t	V _{DD} =15V,I _D =20A	-	6.5	-	nS
Turn-Off Delay Time	$t_{d(off)}$	V_{GS} =10 V , R_{G} =1.6 Ω	-	48	-	nS
Turn-Off Fall Time	t _f		-	7.5	-	nS
Total Gate Charge	Q_g	\/ -45\/ -20A	-	90	-	nC
Gate-Source Charge	Q_{gs}	V_{DS} =15V, I_D =20A, V_{GS} =10V	-	12		nC
Gate-Drain Charge	Q_{gd}	V _{GS} -10V	-	13		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V_{SD}	V_{GS} =0 V , I_{S} =85 A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	170	Α
Reverse Recovery Time	t _{rr}	$T_J = 25^{\circ}C$, $I_F = I_S$	-		30	nS
Reverse Recovery Charge Qri		$di/dt = 100A/\mu s^{(Note3)}$	-		110	nC
					1	

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\mathrm{C}$,V_DD=20V,V_G=10V,L=0.5mH,Rg=25 Ω





Typical Electrical and Thermal Characteristics

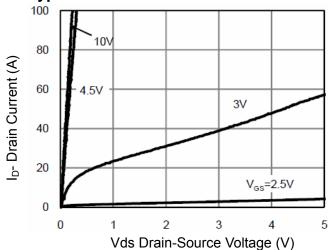


Figure 1 Output Characteristics

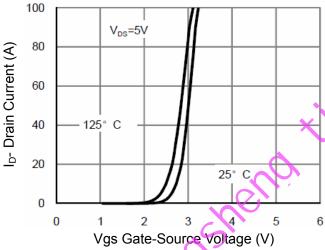
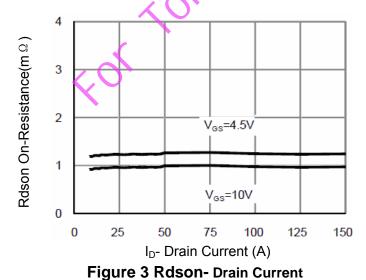


Figure 2 Transfer Characteristics



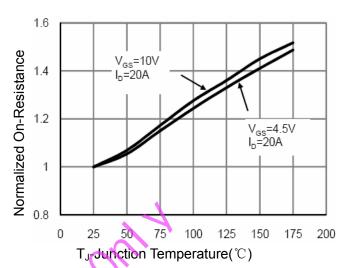


Figure 4 Rdson-Junction Temperature

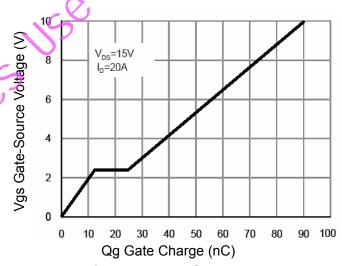


Figure 5 Gate Charge

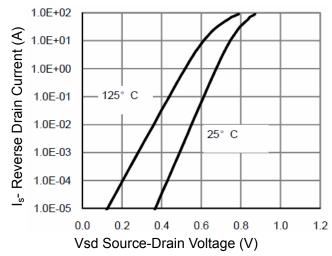


Figure 6 Source- Drain Diode Forward

NCEP30T17GU

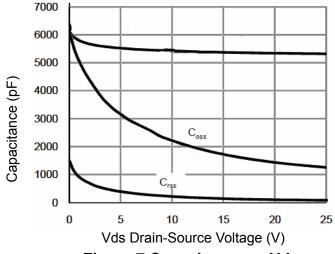


Figure 7 Capacitance vs Vds

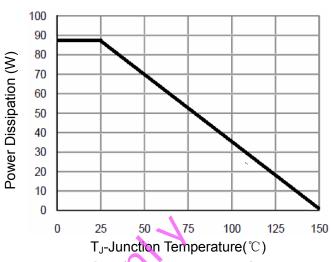


Figure 9 Power De-rating

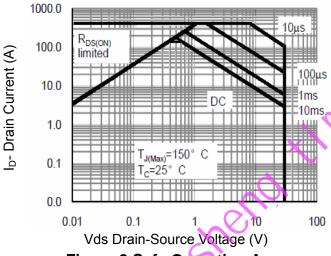


Figure 8 Safe Operation Area

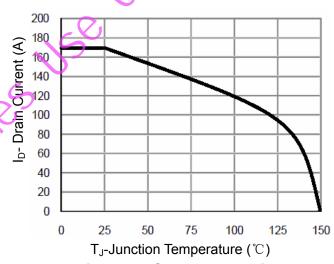


Figure 10 Current De-rating

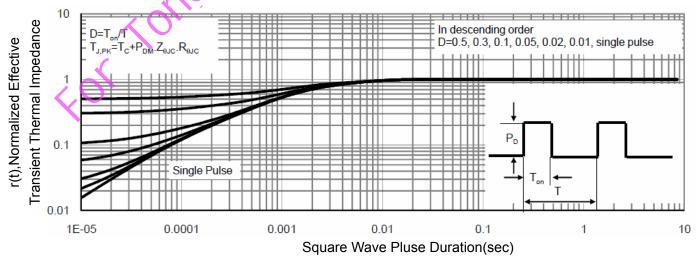
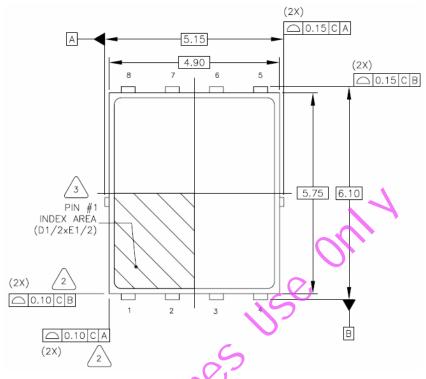
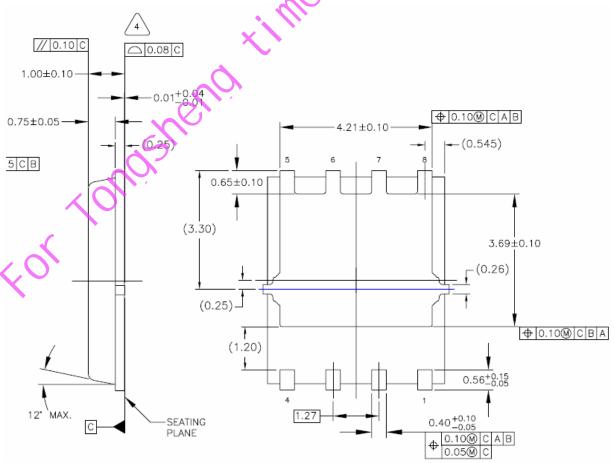


Figure 11 Normalized Maximum Transient Thermal Impedance

DFN5X6-8L Package Information





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